# MAC223A6FP, MAC223A8FP, MAC223A10FP

Preferred Device

# Triacs

### **Silicon Bidirectional Thyristors**

Designed primarily for full-wave ac control applications, such as lighting systems, heater controls, motor controls and power supplies; or wherever full-wave silicon–gate–controlled devices are needed.

- Off–State Voltages to 800 Volts
- All Diffused and Glass Passivated Junctions for Parameter Uniformity and Stability
- Small, Rugged Thermowatt Construction for Thermal Resistance and High Heat Dissipation
- Gate Triggering Guaranteed in Four Modes
- **%** Indicates UL Registered File #E69369
- Device Marking: Logo, Device Type, e.g., MAC223A6FP, Date Code

#### MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit	
Peak Repetitive Off–State Voltage <sup>(1)</sup> (T <sub>J</sub> = -40 to +125°C, Sine Wave 50 to 60 Hz, Gate Open) MAC223A6FP MAC223A8FP MAC223A10FP	Vdrm, Vrrm	400 600 800	Volts	
On-State RMS Current (T <sub>C</sub> = +80°C) <sup>(2)</sup> Full Cycle Sine Wave 50 to 60 Hz	IT(RMS)	25	Amps	
Peak Non–repetitive Surge Current (One Full Cycle, 60 Hz, T <sub>C</sub> = 80°C) Preceded and followed by rated current	ITSM	250	Amps	
Circuit Fusing (t = 8.3 ms)	l <sup>2</sup> t	260	A <sup>2</sup> s	
Peak Gate Power (t ≤ 2 μsec; T <sub>C</sub> = +80°C)	PGM	20	Watts	
Average Gate Power (t = 8.3 ms; T <sub>C</sub> = +80°C)	PG(AV)	0.5	Watt	
Peak Gate Current (t ≤ 2 μsec; T <sub>C</sub> = +80°C)	IGM	2.0	Amps	
Peak Gate Voltage (t ≤ 2 μsec; T <sub>C</sub> = +80°C)	V <sub>GM</sub>	±10	Volts	
RMS Isolation Voltage (T <sub>A</sub> = 25°C, Relative Humidity ≤ 20%) <b>(∿)</b>	V <sub>(ISO)</sub>	1500	Volts	
Operating Junction Temperature	Тj	-40 to +125	°C	
Storage Temperature Range	T <sub>stg</sub>	–40 to +150	°C	
Mounting Torque	—	8.0	in. lb.	

(1) V<sub>DRM</sub> and V<sub>RRM</sub> for all types can be applied on a continuous basis. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

(2) The case temperature reference point for all T<sub>C</sub> measurements is a point on the center lead of the package as close as possible to the plastic body.



#### **ON Semiconductor**

http://onsemi.com

### ISOLATED TRIAC (94) 25 AMPERES RMS 400 thru 800 VOLTS





ISOLATED TO-220 Full Pack CASE 221C STYLE 3

PIN ASSIGNMENT		
1	Main Terminal 1	
2	Main Terminal 2	
3	Gate	

#### **ORDERING INFORMATION**

Device	Package	Shipping
MAC223A6FP	ISOLATED TO220FP	500/Box
MAC223A8FP	ISOLATED TO220FP	500/Box
MAC223A10FP	ISOLATED TO220FP	500/Box

**Preferred** devices are recommended choices for future use and best overall value.

### MAC223A6FP, MAC223A8FP, MAC223A10FP

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	R <sub>θJC</sub>	1.2	°C/W
Thermal Resistance, Case to Sink	R <sub>0CS</sub>	2.2	°C/W
Thermal Resistance, Junction to Ambient	R <sub>θJA</sub>	60	°C/W
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds	т	260	°C

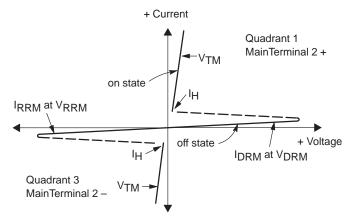
**ELECTRICAL CHARACTERISTICS** ( $T_C = 25^{\circ}C$  unless otherwise noted; Electricals apply in both directions)

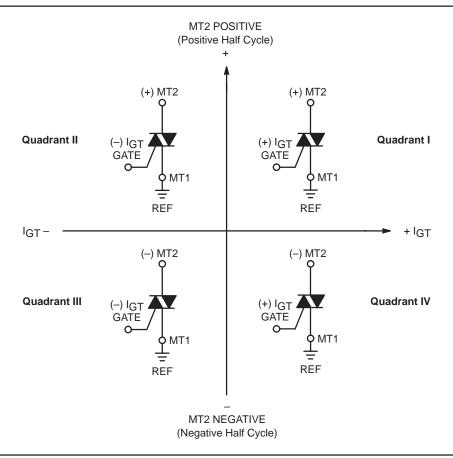
Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS		1			
Peak Repetitive Blocking Current $T_J = 25^{\circ}C$ $(V_D = Rated V_{DRM}, V_{RRM}; Gate Open)$ $T_J = 125^{\circ}C$	I <sub>DRM</sub> , I <sub>RRM</sub>	_	-	10 2.0	μA mA
ON CHARACTERISTICS	-		-	-	
Peak On-State Voltage ( $I_{TM} = \pm 35$ A Peak, Pulse Width $\leq 2$ ms; Duty Cycle $\leq 2\%$ )	V <sub>TM</sub>	-	1.4	1.85	Volts
Gate Trigger Current (Continuous dc) $(V_D = 12 \text{ V}, \text{R}_L = 100 \Omega)$ MT2(+), G(+); MT2(-), G(-); MT2(+), G(-) MT2(-), G(+)	IGT	=	20 30	50 75	mA
Gate Trigger Voltage (Continuous dc) $(V_D = 12 \text{ V}, \text{R}_L = 100 \Omega)$ MT2(+), G(+); MT2(-), G(-); MT2(+), G(-) MT2(-), G(+)	VGT	=	1.1 1.3	2.0 2.5	Volts
Gate Non-trigger Voltage ( $V_D = 12 V, T_J = 125^{\circ}C, R_L = 100 \Omega$ ) All Quadrants	VGD	0.2	0.4	_	Volts
Holding Current (V <sub>D</sub> = 12 Vdc, Gate Open, Initiating Current = $\pm 200$ mA)	Ч	-	10	50	mA
Gate Controlled Turn–On Time (V <sub>D</sub> = Rated V <sub>DRM</sub> , I <sub>TM</sub> = 35 A Peak, I <sub>G</sub> = 200 mA)	tgt	-	1.5	-	μs
DYNAMIC CHARACTERISTICS	•	•	•	•	
Critical Rate of Rise of Off–State Voltage ( $V_D$ = Rated V <sub>DRM</sub> , Exponential Waveform, T <sub>C</sub> = 125°C)	dv/dt	-	40	-	V/µs
Critical Rate of Rise of Commutation Voltage ( $V_D$ = Rated $V_{DRM}$ , $I_{TM}$ = 35 A Peak, Commutating di/dt = 12.6 A/ms, Gate Unenergized, $T_C$ = 80°C)	dv/dt(c)	-	5.0	_	V/µs

#### MAC223A6FP, MAC223A8FP, MAC223A10FP

#### Voltage Current Characteristic of Triacs (Bidirectional Device)

Symbol	Parameter
VDRM	Peak Repetitive Forward Off State Voltage
IDRM	Peak Forward Blocking Current
VRRM	Peak Repetitive Reverse Off State Voltage
IRRM	Peak Reverse Blocking Current
VTM	Maximum On State Voltage
Ι <sub>Η</sub>	Holding Current



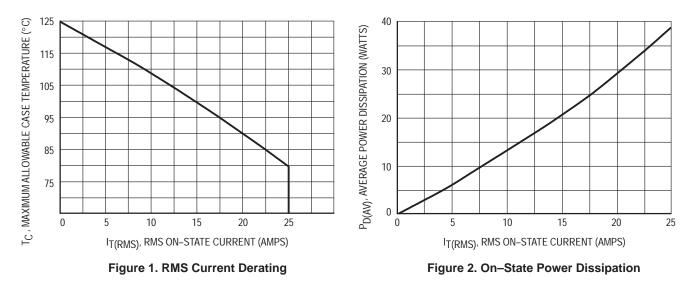


#### **Quadrant Definitions for a Triac**

All polarities are referenced to MT1.

With in-phase signals (using standard AC lines) quadrants I and III are used.

### MAC223A6FP, MAC223A8FP, MAC223A10FP



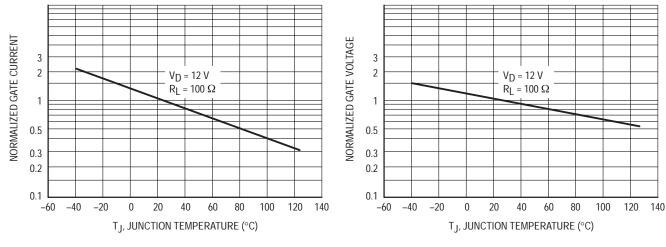


Figure 3. Typical Gate Trigger Current



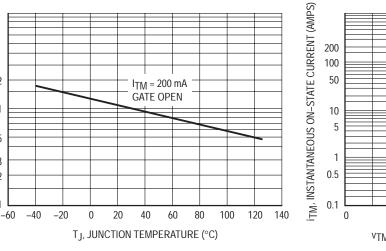


Figure 5. Typical Hold Current

NORMALIZED HOLD CURRENT

2

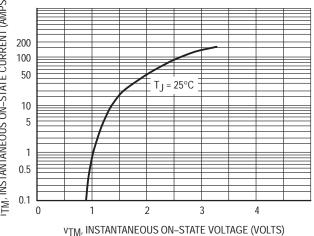
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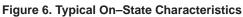
0.5

0.3

0.2

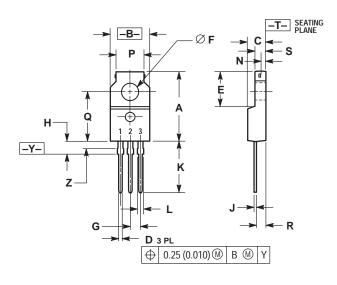
0.1





#### PACKAGE DIMENSIONS

**ISOLATED TO-220 Full Pack** CASE 221C-02 ISSUE C



NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. LEAD DIMENSIONS UNCONTROLLED WITHIN DIMENSION Z.

	INCHES		ES MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.680	0.700	17.28	17.78
В	0.388	0.408	9.86	10.36
С	0.175	0.195	4.45	4.95
D	0.025	0.040	0.64	1.01
Ε	0.340	0.355	8.64	9.01
F	0.140	0.150	3.56	3.81
G	0.100 BSC		2.54 BSC	
Н	0.110	0.155	2.80	3.93
J	0.018	0.028	0.46	0.71
К	0.500	0.550	12.70	13.97
L	0.045	0.070	1.15	1.77
Ν	0.049		1.25	
Р	0.270	0.290	6.86	7.36
Q	0.480	0.500	12.20	12.70
R	0.090	0.120	2.29	3.04
S	0.105	0.115	2.67	2.92
Z	0.070	0.090	1.78	2.28

STYLE 3: PIN 1. MT 1

2. MT 2 3. GATE

# **Notes**

# **Notes**

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